

SN74ALVCH16843 18-BIT BUS-INTERFACE D-TYPE LATCH WITH 3-STATE OUTPUTS

SCES044 – JULY 1995

- Member of the Texas Instruments *Widebus™* Family
- *EPIC™* (Enhanced-Performance Implanted CMOS) Submicron Process
- Bus Hold on Data Inputs Eliminates the Need for External Pullup/Pulldown Resistors
- Package Options Include Plastic 300-mil Shrink Small-Outline (DL) and Thin Shrink Small-Outline (DGG) Packages

description

This 18-bit bus-interface D-type latch is designed for 2.3-V to 3.6-V V_{CC} operation.

The SN74ALVCH16843 features 3-state outputs designed specifically for driving highly capacitive or relatively low-impedance loads. This device is particularly suitable for implementing buffer registers, unidirectional bus drivers, and working registers.

The SN74ALVCH16843 can be used as two 9-bit latches or one 18-bit latch. The 18 latches are transparent D-type latches. The device has noninverting data (D) inputs and provides true data at its outputs.

A buffered output-enable (\overline{OE}) input can be used to place the nine outputs in either a normal logic state (high or low logic levels) or a high-impedance state. The outputs also are in the high-impedance state during power-up and power-down conditions. The outputs remain in the high-impedance state while the device is powered down. In the high-impedance state, the outputs neither load nor drive the bus lines significantly. The high-impedance state and increased drive provide the capability to drive bus lines without need for interface or pullup components.

The output-enable (\overline{OE}) input does not affect the internal operations of the latch. Previously stored data can be retained or new data can be entered while the outputs are in the high-impedance state.

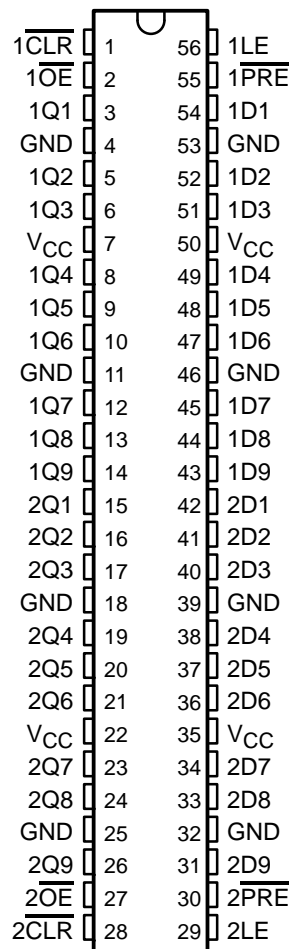
To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

Active bus-hold circuitry is provided to hold unused or floating inputs at a valid logic level.

The SN74ALVCH16843 is available in TI's shrink small-outline (DL) and thin shrink small-outline (DGG) packages, which provide twice the I/O pin count and functionality of standard small-outline packages in the same printed-circuit-board area.

The SN74ALVCH16843 is characterized for operation from -40°C to 85°C .

DGG OR DL PACKAGE
(TOP VIEW)



PRODUCT PREVIEW



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**TEXAS
INSTRUMENTS**

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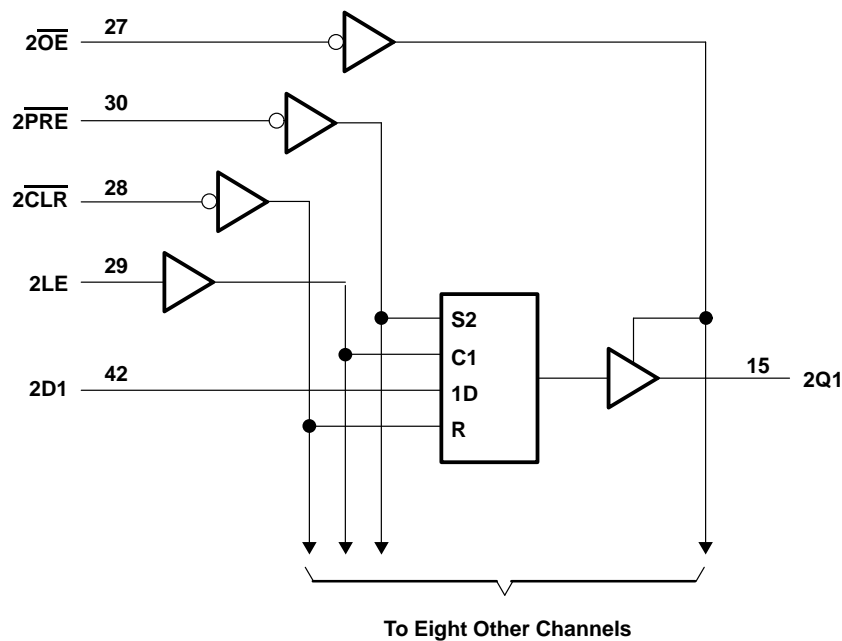
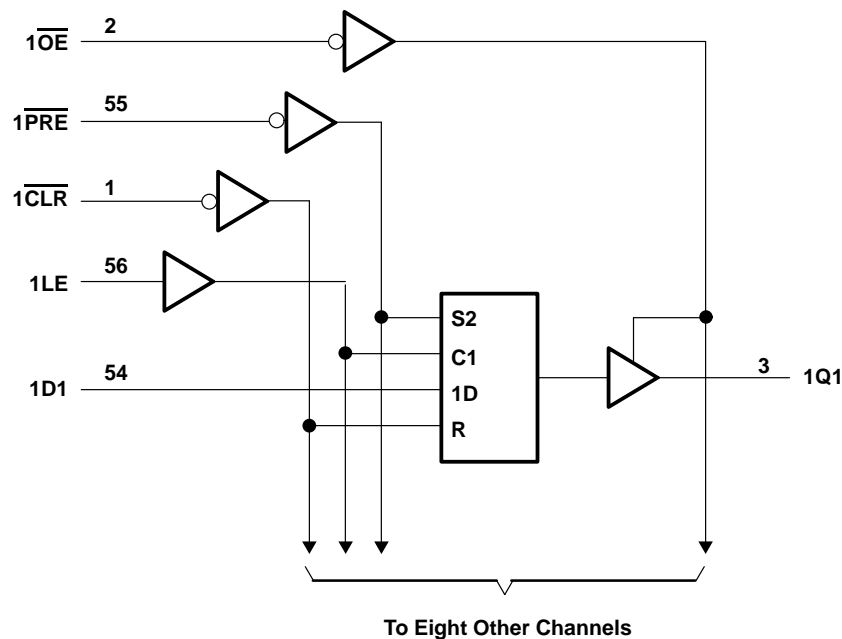
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logic diagram (positive logic)



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FUNCTION TABLE
(each 9-bit latch)

INPUTS					OUTPUT Q
$\overline{\text{PRE}}$	$\overline{\text{CLR}}$	$\overline{\text{OE}}$	LE	D	
L	X	L	X	X	H
H	L	L	X	X	L
H	H	L	H	L	L
H	H	L	H	H	H
H	H	L	L	X	Q ₀
X	X	H	X	X	Z

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

Supply voltage range, V_{CC}	–0.5 V to 4.6 V
Input voltage range, V_I (see Note 1)	–0.5 V to 4.6 V
Output voltage range, V_O (see Notes 1 and 2)	–0.5 V to $V_{CC} + 0.5$ V
Input clamp current, I_{IK} ($V_I < 0$)	–50 mA
Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$)	±50 mA
Continuous output current, I_O ($V_O = 0$ to V_{CC})	±50 mA
Continuous current through each V_{CC} or GND	±100 mA
Maximum power dissipation at $T_A = 55^\circ\text{C}$ (in still air) (see Note 3): DGG package	1 W
DL package	1.4 W
Storage temperature range, T_{stg}	–65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES: 1. The input and output negative-voltage ratings may be exceeded if the input and output clamp-current ratings are observed.
2. This value is limited to 4.6 V maximum.
3. The maximum package power dissipation is calculated using a junction temperature of 150°C and a board trace length of 750 mils. For more information, refer to the *Package Thermal Considerations* application note in the 1994 *ABT Advanced BiCMOS Technology Data Book*, literature number SCBD002B.

recommended operating conditions (see Note 4)

		MIN	MAX	UNIT
V_{CC}	Supply voltage	2.3	3.6	V
V_{IH}	High-level input voltage	$V_{CC} = 2.3$ V to 2.7 V	1.7	V
		$V_{CC} = 2.7$ V to 3.6 V	2	
V_{IL}	Low-level input voltage	$V_{CC} = 2.3$ V to 2.7 V	0.7	V
		$V_{CC} = 2.7$ V to 3.6 V	0.8	
V_I	Input voltage	0	V_{CC}	V
V_O	Output voltage	0	V_{CC}	V
I_{OH}	High-level output current	$V_{CC} = 2.3$ V	–12	mA
		$V_{CC} = 2.7$ V	–12	
		$V_{CC} = 3$ V	–24	
I_{OL}	Low-level output current	$V_{CC} = 2.3$ V	12	mA
		$V_{CC} = 2.7$ V	12	
		$V_{CC} = 3$ V	24	
$\Delta t/\Delta v$	Input transition rise or fall rate	0	10	ns/V
T_A	Operating free-air temperature	–40	85	°C

NOTE 4: Unused control inputs must be held high or low to prevent them from floating.

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electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		V _{CC} [†]	MIN	TYP [‡]	MAX	UNIT	
V _{OH}	I _{OH} = −100 μA		MIN to MAX		V _{CC} −0.2			V	
	I _{OH} = −6 mA, V _{IH} = 1.7 V		2.3 V		2				
	I _{OH} = −12 mA	V _{IH} = 1.7 V	2.3 V		1.7				
		V _{IH} = 2 V	2.7 V		2.2				
		V _{IH} = 2 V	3 V		2.4				
	I _{OH} = −24 mA, V _{IH} = 2 V		3 V		2				
V _{OL}	I _{OL} = 100 μA		MIN to MAX				0.2	V	
	I _{OL} = 6 mA, V _{IL} = 0.7 V		2.3 V				0.4		
	I _{OL} = 12 mA	V _{IL} = 0.7 V	2.3 V				0.7		
		V _{IL} = 0.8 V	2.7 V				0.4		
	I _{OL} = 24 mA, V _{IL} = 0.8 V		3 V				0.55		
I _I	V _I = V _{CC} or GND		3.6 V				±5	μA	
I _I (hold)	V _I = 0.7 V		2.3 V		45			μA	
	V _I = 1.7 V				−45				
	V _I = 0.8 V		3 V		75				
	V _I = 2 V				−75				
	V _I = 0 to 3.6 V		3.6 V				±500		
I _{OZ}	V _O = V _{CC} or GND		3.6 V				±10	μA	
I _{CC}	V _I = V _{CC} or GND, I _O = 0		3.6 V				40	μA	
ΔI _{CC}		One input at V _{CC} − 0.6 V, Other inputs at V _{CC} or GND		3 V to 3.6 V				750	μA
C _i	Control inputs	V _I = V _{CC} or GND		3.3 V				pF	
	Data inputs								
C _O	Outputs	V _O = V _{CC} or GND		3.3 V				pF	

† For conditions shown as MIN or MAX, use the appropriate values under recommended operating conditions.

‡ Typical values are measured at $V_{CC} = 3.3 \text{ V}$, $T_A = 25^{\circ}\text{C}$.

PRODUCT PREVIEW



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